



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Won Sun Shin, et al.

Assignee: Amkor Technology, Inc.

Title: SEMICONDUCTOR PACKAGE AND METHOD FOR FABRICATING
THE SAME

Serial No.: 10/825,670 Filed: April 14, 2004

Examiner: Chuong A. Luu Group Art 2818
Unit:

Docket No.: GK0012RI

Monterey, CA
June 14, 2007

Mail Stop Reissue
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

Dear Sir:

This is in response to the Office Action dated March 15, 2007:

1. Remarks begin on page 2 of this paper.